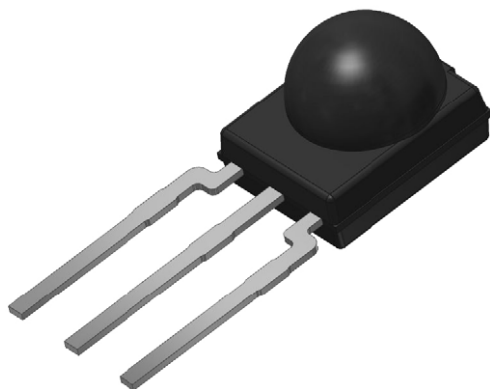


IR Receiver Modules for Remote Control Systems



MECHANICAL DATA

Pinning for TSOP53...:

1 = OUT, 2 = GND, 3 = V_S

FEATURES

- Improved immunity against HF and RF noise
- Low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- Improved immunity against optical noise
- Insensitive to supply voltage ripple and noise
- Compatible with wave or reflow soldering (see "P" version of Minimold option datasheets)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

DESCRIPTION

The TSOP531.., TSOP533.., and TSOP535.. series are miniaturized IR receiver modules for infrared remote control systems. A PIN diode and a preamplifier are assembled on lead frame, the epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding.

The TSOP533.. series devices are optimized to suppress almost all spurious pulses from Wi-Fi and CFL sources. They may suppress some data signals if continuously transmitted.

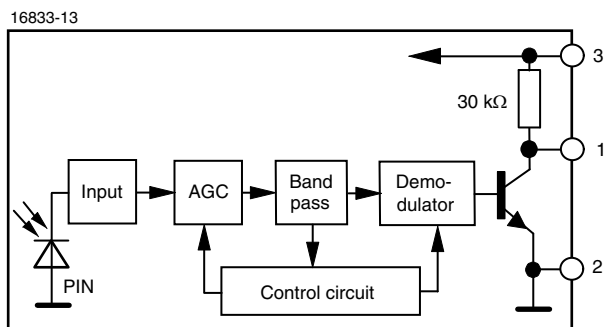
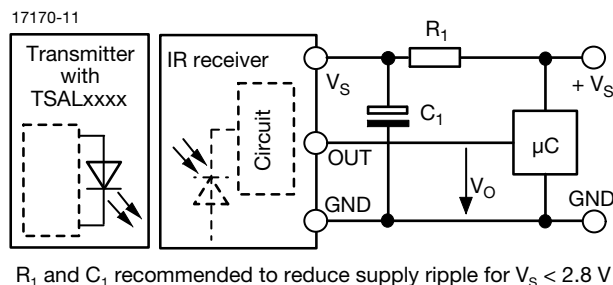
The TSOP531.. series devices are provided primarily for compatibility with old AGC1 designs. New designs should prefer the TSOP533.. series containing the newer AGC3.

The TSOP535.. series are useful to suppress even extreme levels of optical noise, but may also suppress some data signals. Please check compatibility with your codes.

These components have not been qualified according to automotive specifications.

PARTS TABLE

AGC		LEGACY, FOR SHORT BURSTS (AGC1)	FOR SHORT BURSTS, NOISY ENVIRONMENTS (AGC3)	FOR SHORT BURSTS, VERY NOISY ENVIRONMENTS (AGC5)
Carrier frequency	30 kHz	TSOP53130	TSOP53330	TSOP53530
	33 kHz	TSOP53133	TSOP53333	TSOP53533
	36 kHz	TSOP53136	TSOP53336 ⁽¹⁾	TSOP53536
	38 kHz	TSOP53138	TSOP53338 ⁽²⁾⁽³⁾⁽⁴⁾⁽⁵⁾	TSOP53538
	40 kHz	TSOP53140	TSOP53340	TSOP53540
	56 kHz	TSOP53156	TSOP53356	TSOP53556
Package		Minimold		
Pinning		1 = OUT, 2 = GND, 3 = V_S		
Dimensions (mm)		5.4 W x 6.35 H x 4.9 D		
Mounting		Leaded		
Application		Remote control		
Best remote control code		⁽¹⁾ MCIR ⁽²⁾ Mitsubishi ⁽³⁾ RECS-80 Code ⁽⁴⁾ r-map ⁽⁵⁾ XMP-1		

**BLOCK DIAGRAM****APPLICATION CIRCUIT****ABSOLUTE MAXIMUM RATINGS**

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V_S	-0.3 to +6	V
Supply current		I_S	5	mA
Output voltage		V_O	-0.3 to 5.5	V
Voltage at output to supply		$V_S - V_O$	-0.3 to $(V_S + 0.3)$	V
Output current		I_O	5	mA
Junction temperature		T_j	100	°C
Storage temperature range		T_{stg}	-25 to +85	°C
Operating temperature range		T_{amb}	-25 to +85	°C
Power consumption	$T_{amb} \leq 85^\circ\text{C}$	P_{tot}	10	mW
Soldering temperature	$t \leq 10\text{ s}$, 1 mm from case	T_{sd}	260	°C

Note

- Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL AND OPTICAL CHARACTERISTICS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current	$E_v = 0$, $V_S = 5\text{ V}$	I_{SD}	0.55	0.7	0.9	mA
	$E_v = 40\text{ klx}$, sunlight	I_{SH}	-	0.8	-	mA
Supply voltage		V_S	2.5	-	5.5	V
Transmission distance	$E_v = 0$, test signal see Fig. 1, IR diode TSAL6200, $I_F = 200\text{ mA}$	d	-	45	-	m
Output voltage low	$I_{OSL} = 0.5\text{ mA}$, $E_e = 0.7\text{ mW/m}^2$, test signal see Fig. 1	V_{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see Fig. 1	$E_e\text{ min.}$	-	0.12	0.25	mW/m ²
Maximum irradiance	$t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see Fig. 1	$E_e\text{ max.}$	50	-	-	W/m ²
Directivity	Angle of half transmission distance	$\phi_{1/2}$	-	± 45	-	deg

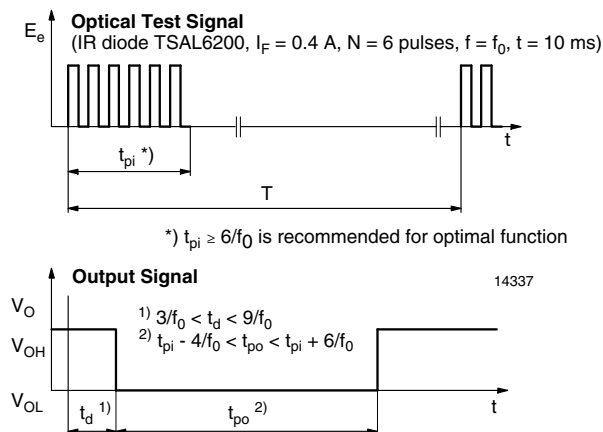
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Output Active Low

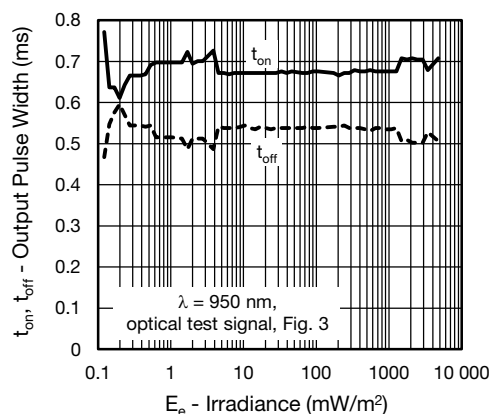


Fig. 4 - Output Pulse Diagram

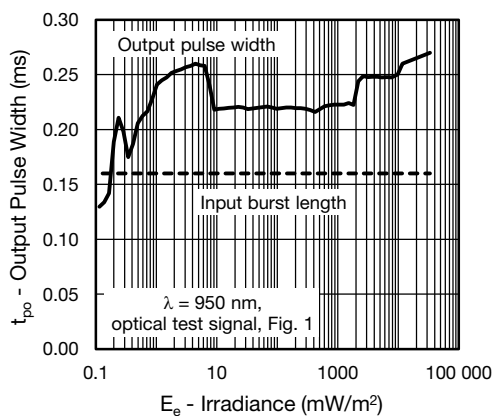


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

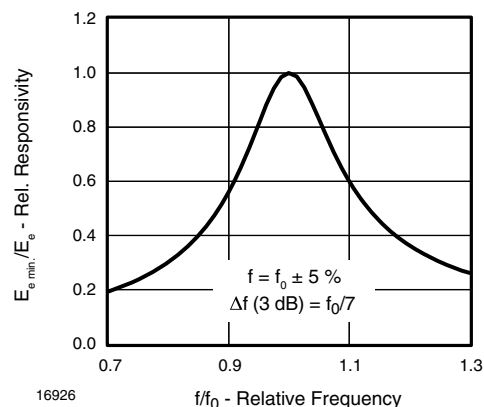


Fig. 5 - Frequency Dependence of Responsivity

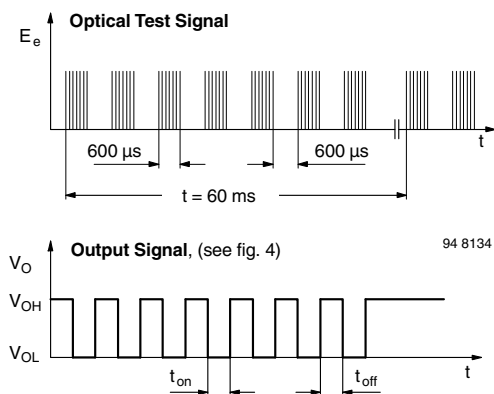


Fig. 3 - Output Function

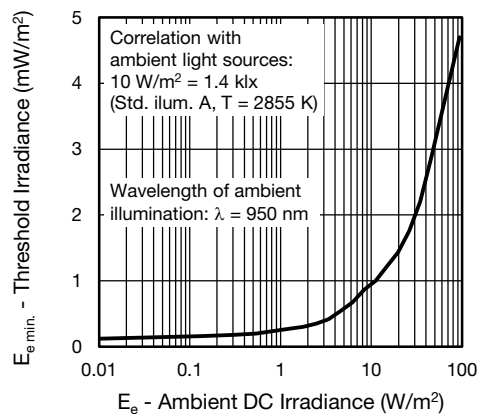


Fig. 6 - Sensitivity in Bright Ambient

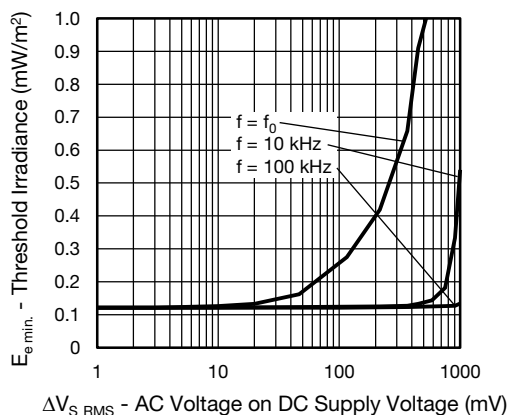


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

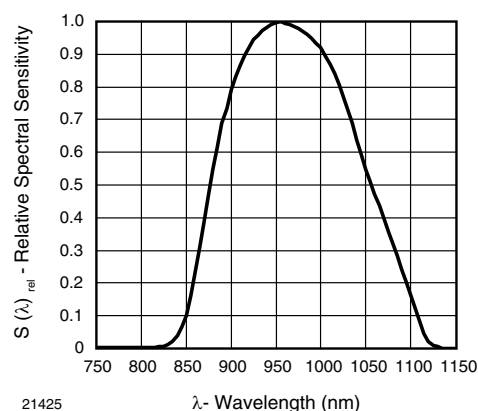


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

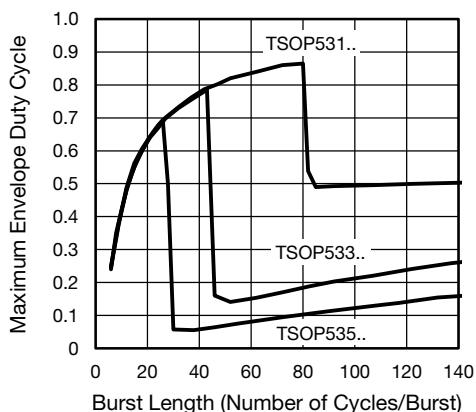


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

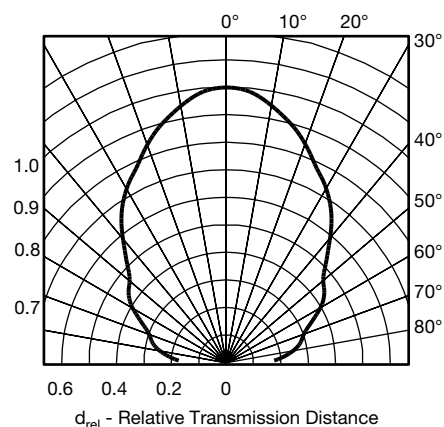


Fig. 11 - Horizontal Directivity

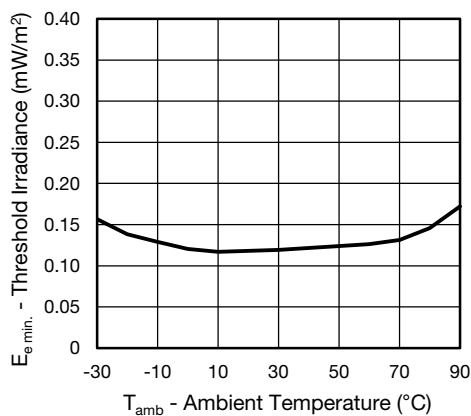


Fig. 9 - Sensitivity vs. Ambient Temperature

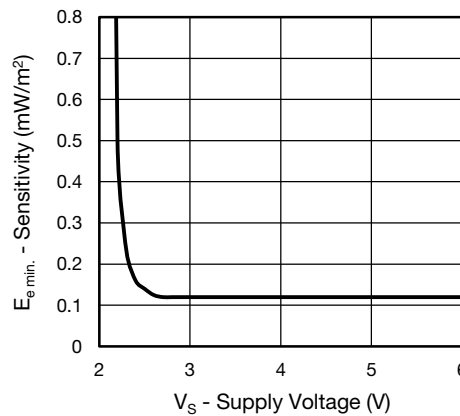


Fig. 12 - Sensitivity vs. Supply Voltage

SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal presented to the device in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14).
- 2.4 GHz and 5 GHz Wi-Fi

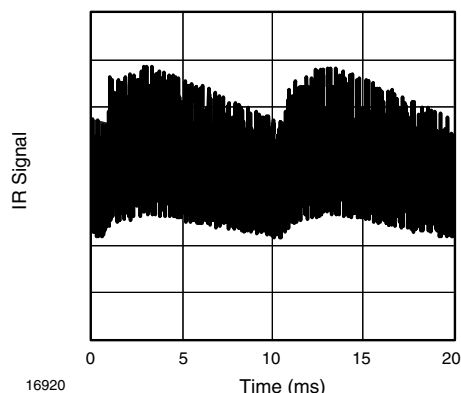


Fig. 13 - IR Disturbance from Fluorescent Lamp with Low Modulation

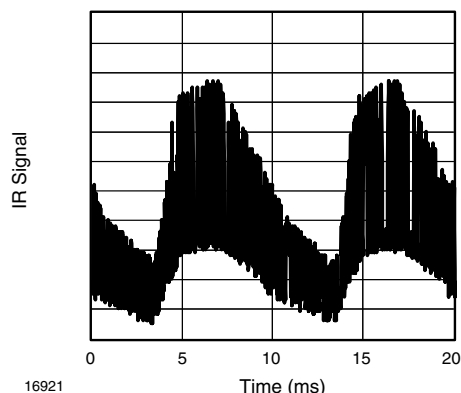


Fig. 14 - IR Disturbance from Fluorescent Lamp with High Modulation

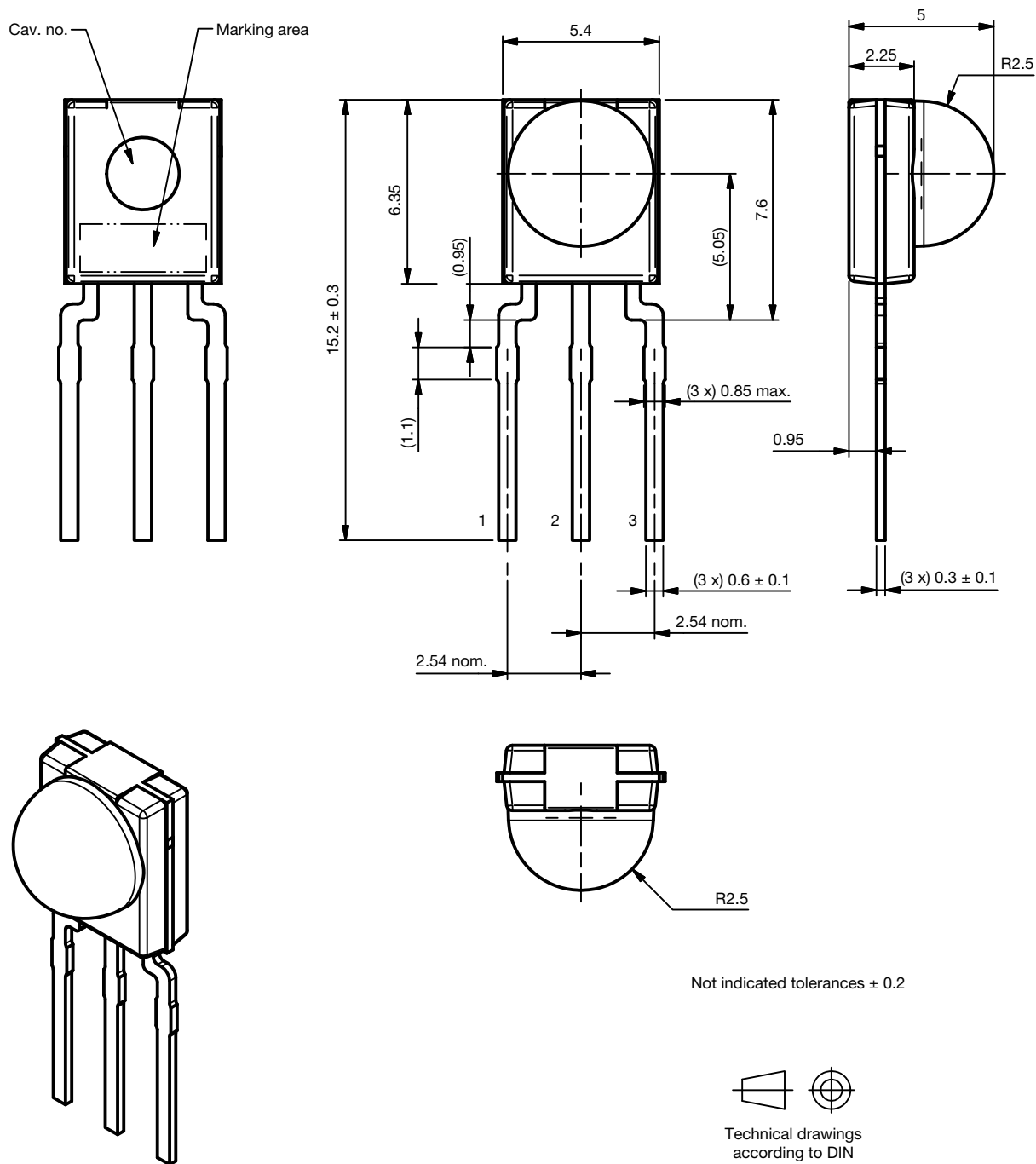
	TSOP531..	TSOP533..	TSOP535..
Minimum burst length	6 cycles/burst	6 cycles/burst	6 cycles/burst
After each burst of length A gap time is required of	6 to 70 cycles ≥ 10 cycles	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 1.2 x burst length	35 cycles > 6 x burst length	24 cycles > 25 ms
Maximum number of continuous short bursts/second	2000	2000	2000
MCIR code	Yes	Preferred	Yes
XMP-1 code	Yes	Preferred	Yes
Suppression of interference from fluorescent lamps	Mild disturbance patterns are suppressed (example: signal pattern of Fig. 13)	Complex disturbance patterns are suppressed (example: signal pattern of Fig. 14)	Critical disturbance patterns are suppressed, e.g. highly dimmed LCDs

Note

- For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP532.., TSOP534..



PACKAGE DIMENSIONS in millimeters



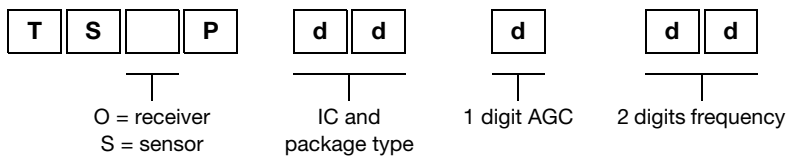
Drawing no.: 6.550-5335.01-4
Issue: 1; 16.09.15



BULK PACKAGING

Standard shipping for minimold is in conductive plastic bags. The packing quantity is determined by weight and a maximum of 0.3 % of the components per carton may be missing.

ORDERING INFORMATION



Note

- d = "digit", please consult the list of available series to create a valid part number.

Examples: TSOP53338

TSOP53356V11

TSOP53338SS1F

PACKAGING QUANTITY

- 300 pieces per bag (each bag is individually boxed).
- 6 bags per carton



Tape and Reel Standards for SMD IR Receiver Modules

Vishay Semiconductor SMD IR receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Type
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

- A. Panhead SMD: quantity per reel:
 - TT, SMD top view package, 1190 pcs
 - TR, SMD side view package, 1120 pcs
- B. Heimdall: quantity per reel:
 - TT, Heimdall top view package, 2200 pcs
 - TR, Heimdall side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel:
 - WTT, top view package, 2200 pcs
 - WTR, side view package, 2300 pcs
- D. Belobog: quantity per reel:
 - TT1, 1800 pcs
 - TT2, 7000 pcs
 - TR, not available in side view
- E. Belobog with shield: quantity per reel:
 - TT1, 1500 pcs
 - TT2, 5000 pcs
- F. Minimold DF1P: quantity per reel:
 - DF1P, 1100 pcs

ORDER DESIGNATION

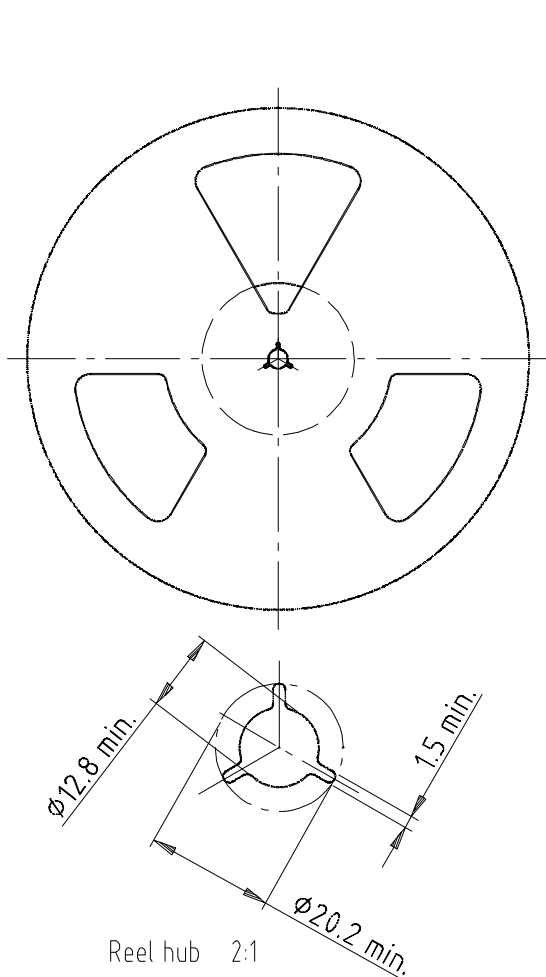
The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

- TSOP6238TR (reel packing)
- TSOP75238TR (reel packing)
- TSOP75338WTT (reel packing)
- TSOP57438TT1 (reel packing)
- TSOP57238HTT1 (reel packing)



REEL DIMENSIONS FOR PANHEAD SMD AND HEIMDALL in millimeters



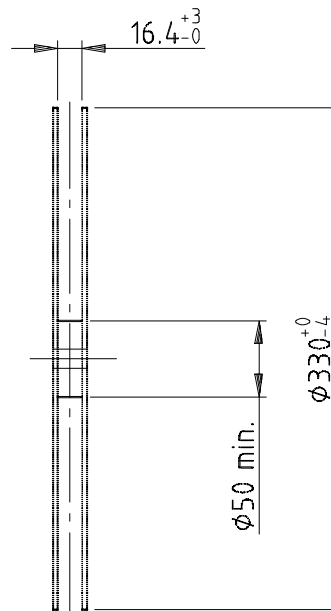
Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

Note

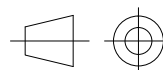
- The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

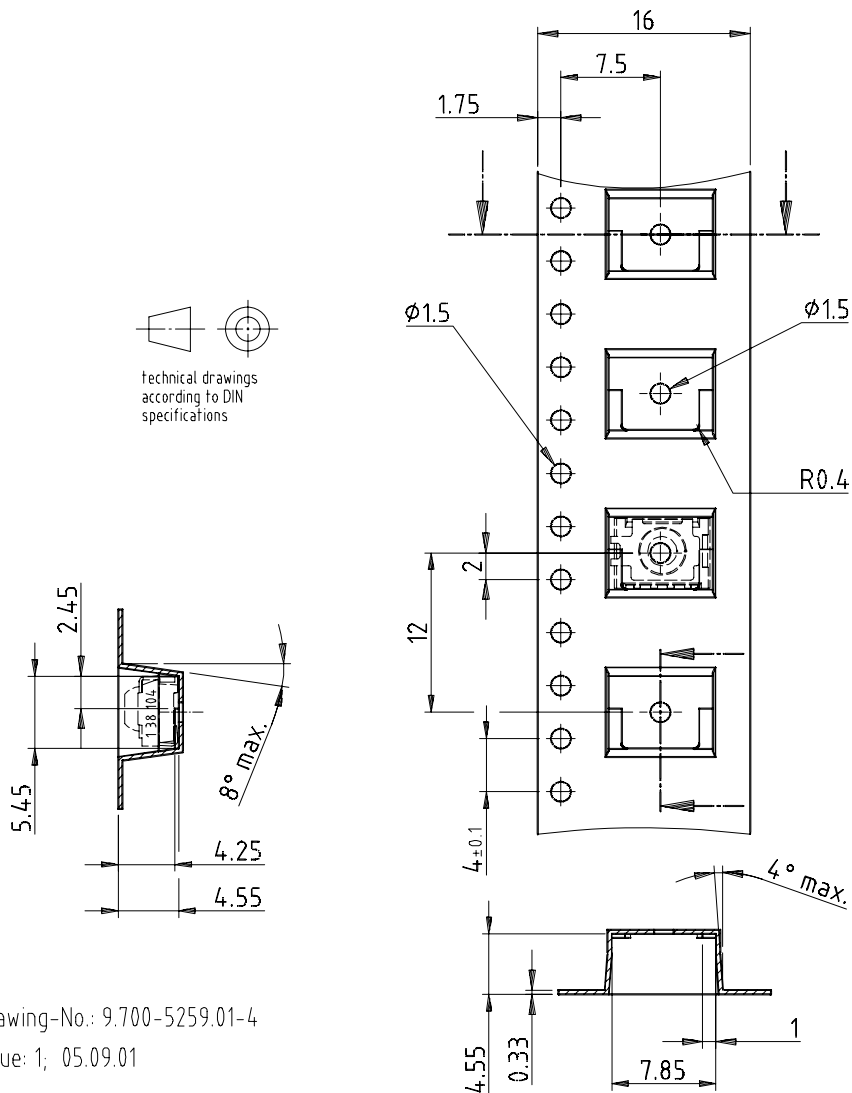
Tape width 16



technical drawings
according to DIN
specifications

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

A. Panhead SMD (TSOP36...TT, TSSP....TT, TSOP6...TT)



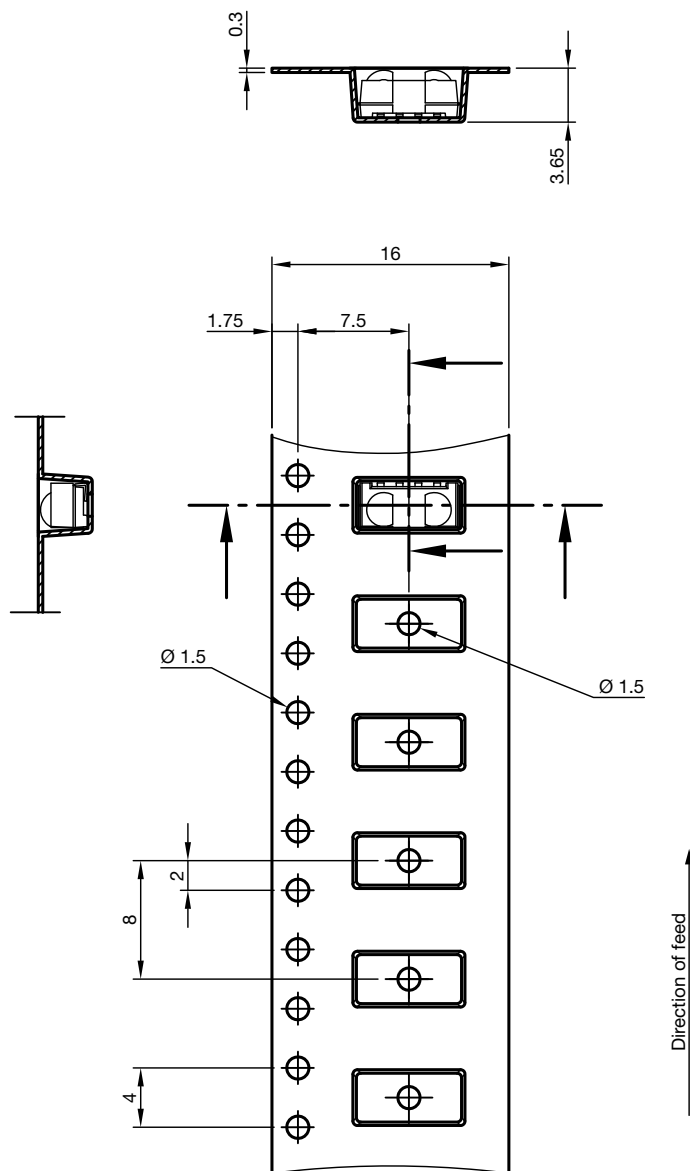
Drawing-No.: 9.700-5259.01-4

Issue: 1; 05.09.01

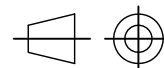
16584

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75...TT, TSOP77...TT, TSSP77...TT)



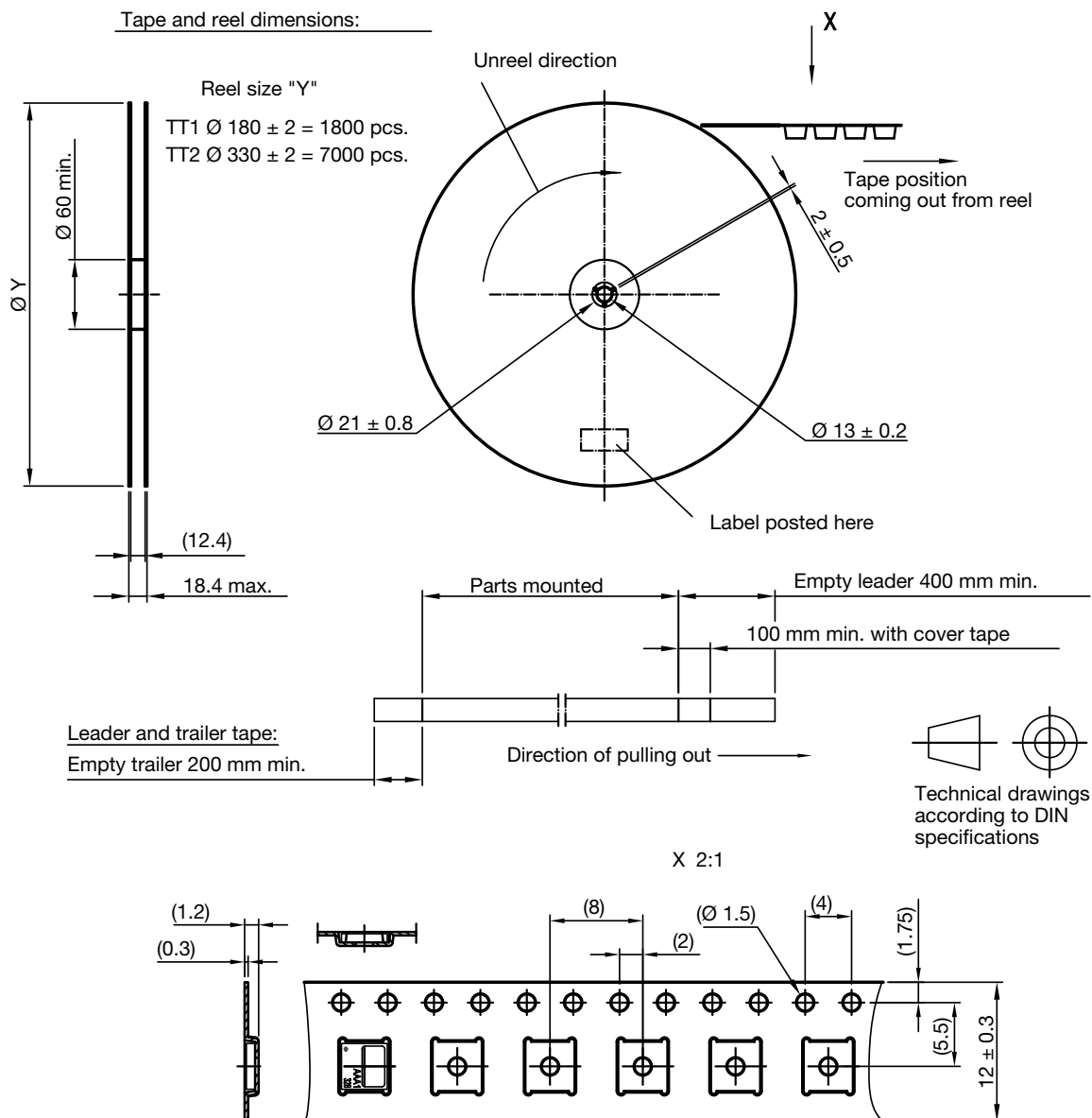
Drawing-No.: 9.700-5338.01-4
Issue: 4; 12.06.13



technical drawings
according to DIN
specifications

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

D. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2)



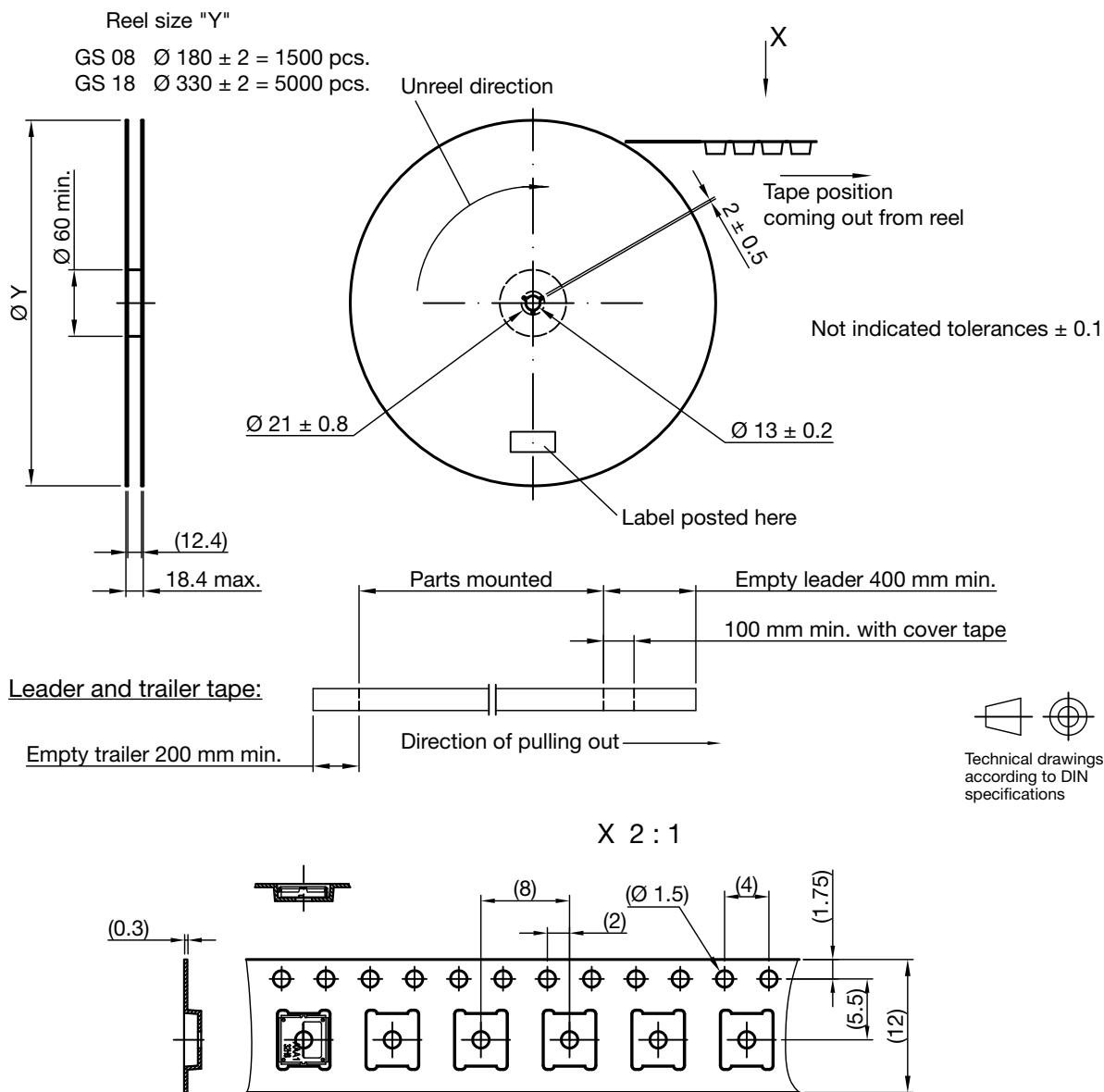
Drawing-No.: 9.700-5347.01-4
Issue: 1; 14.11.11

Not indicated tolerances ± 0.1

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

E. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2)

Tape and Reel dimensions:



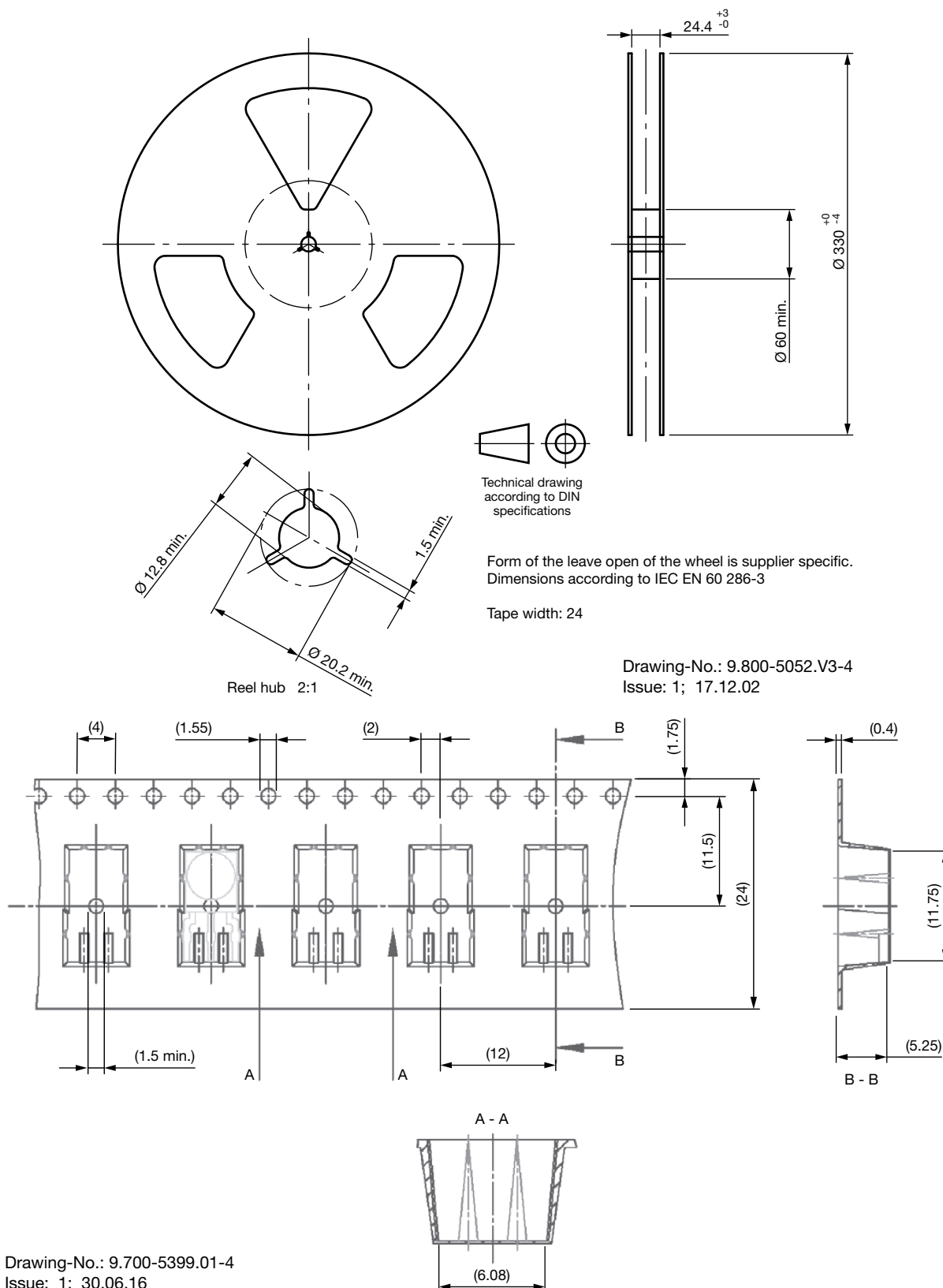
Reel dimensions and tape

Drawing-No.: 9.700-5380.01-4
Issue: 1; 28.10.13



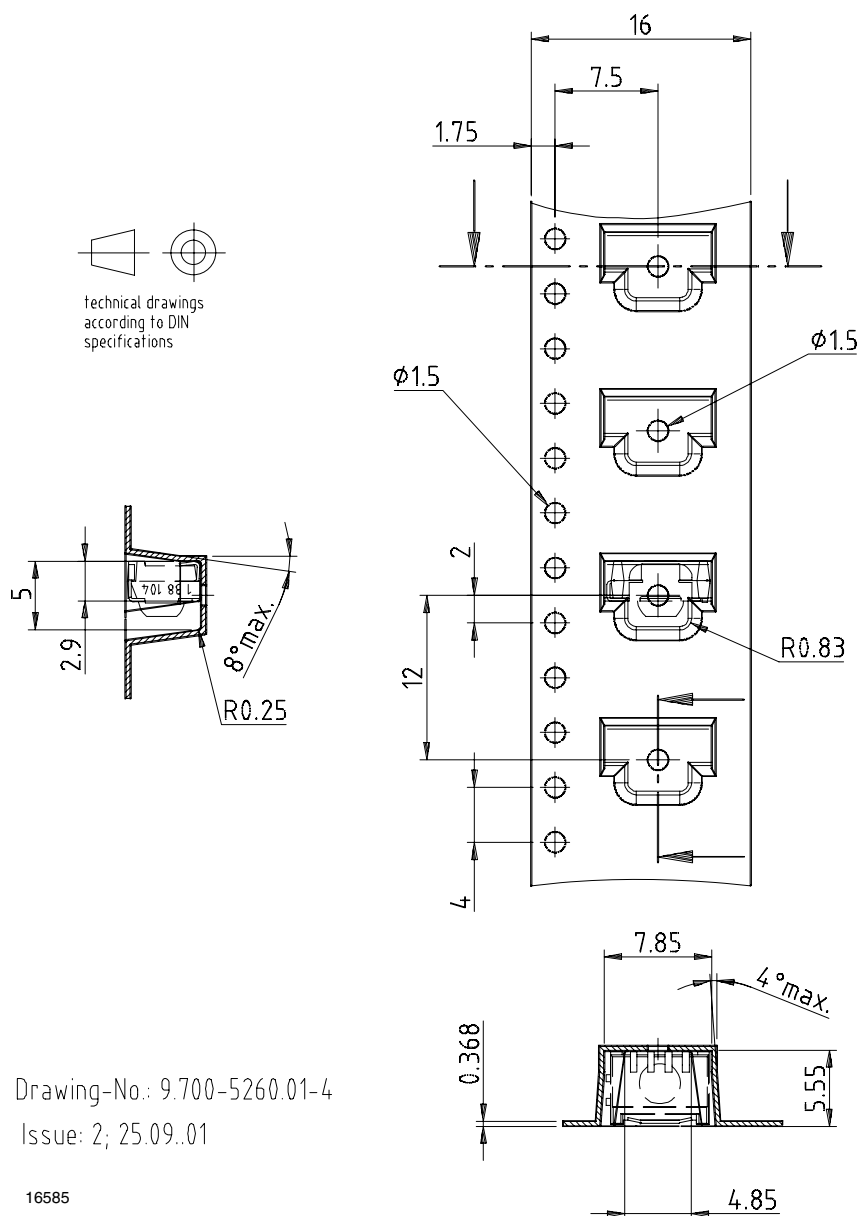
TAPING VERSION TSOP..DF1P (SIDE VIEW) DIMENSIONS in millimeters

F. Minimold DF1P (TSOP33...DF1P, TSOP53...DF1P)



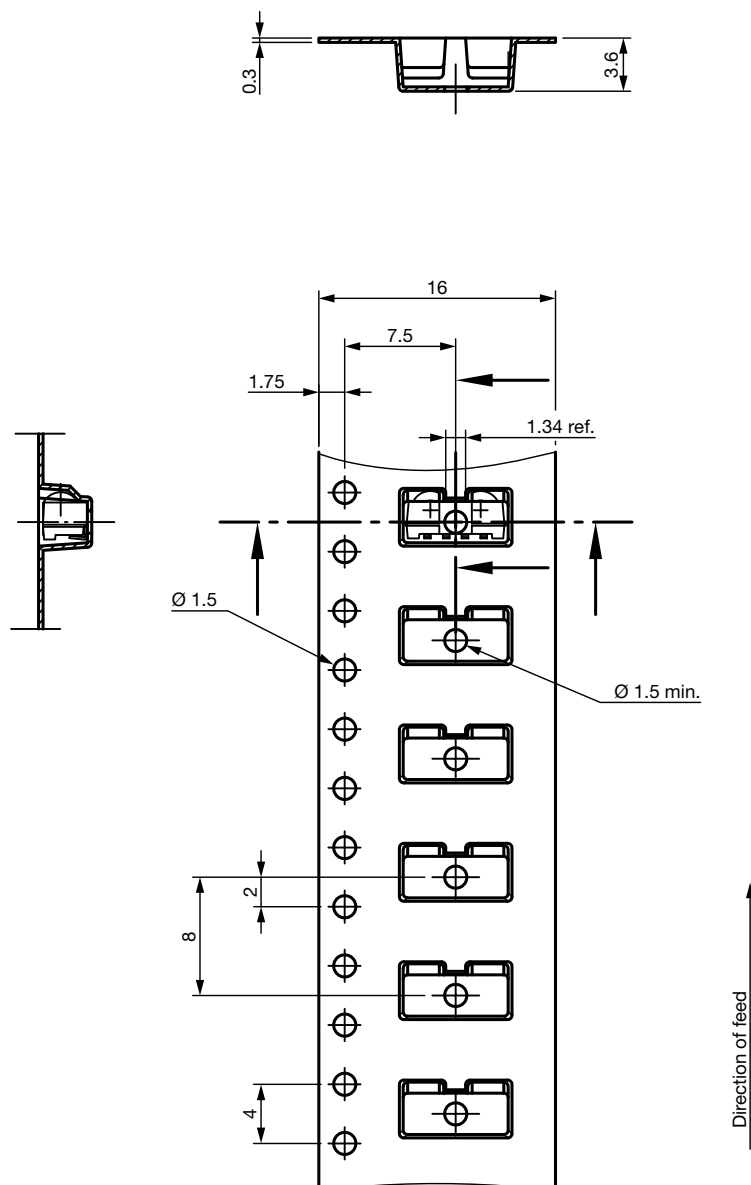
TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

A. Panhead SMD (TSOP36...TR, TSSP6...TR, TSOP6...TR)

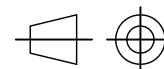


TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75..., TSOP77..., TSSP7....)



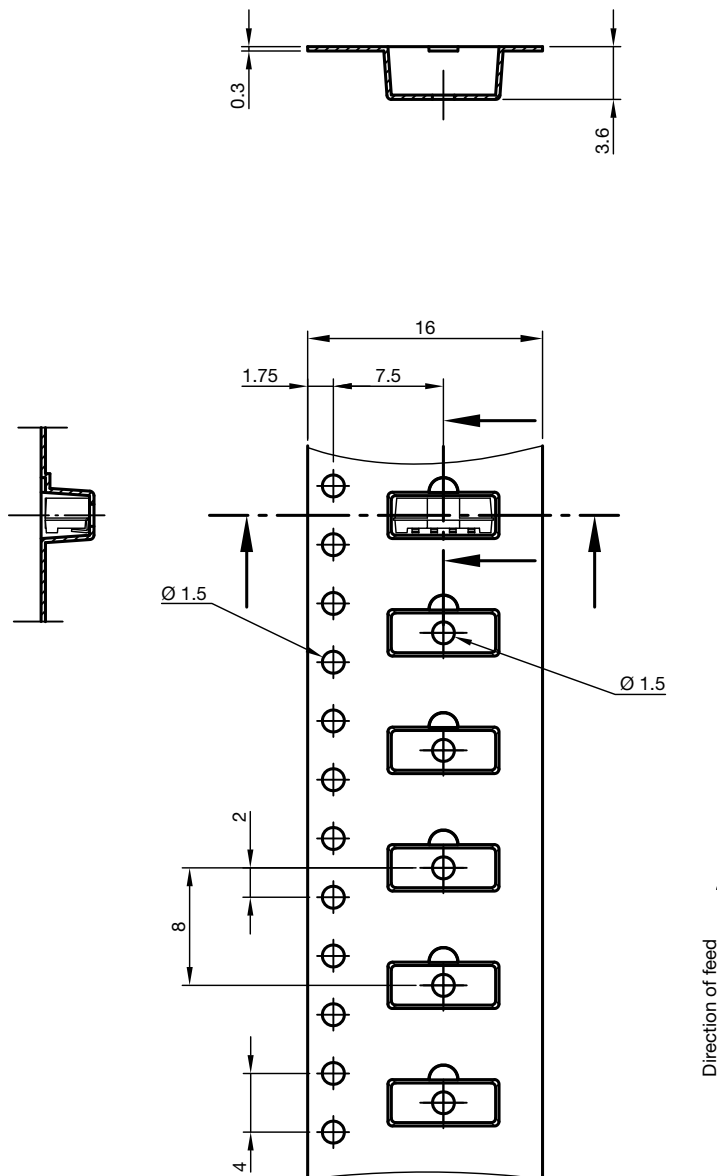
Drawing-No.: 9.700-5337.01-4
Issue: 2; 06.10.15



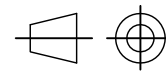
technical drawings
according to DIN
specifications

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

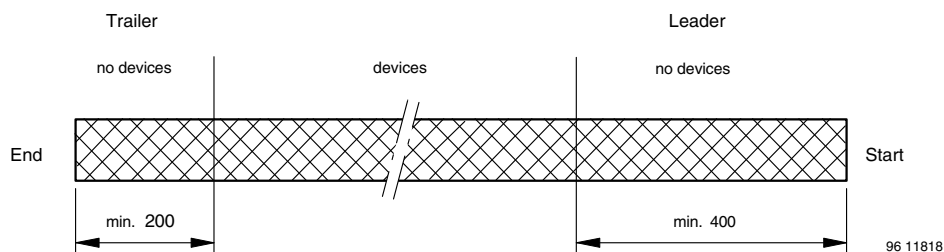
C. Heimdall SMD without lens (TSOP75...WTR, TSOP77...WTR, TSSP...WTR)



Drawing-No.: 9.700-5342.01-4
Issue: 2; 12.06.13


technical drawings
according to DIN
specifications

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min. $\pm$ 10 mm/min.

165° to 180° peel angle

LABEL

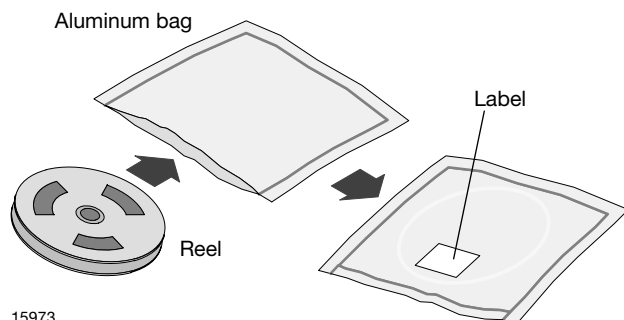
Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE TOP	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

**DRY PACKAGING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JSTD-020 level 4 label is included on all dry bags.

	CAUTION This bag contains MOISTURE-SENSITIVE DEVICES	LEVEL 4
	1. Shelf life in sealed bag: 12 months at < 40 °C and < 90 % relative humidity (RH) 2. After this bag is opened, devices that will be subjected to soldering reflow or equivalent processing (peak package body temp. 260 °C) must be: 2a. Mounted within 72 hours at factory condition of < 30 °C/60 % RH or 2b. Stored at < 5 % RH 3. Devices require baking before mounting if: Humidity Indicator Card is > 10 % when read at 23 °C ± 5 °C or 2a. or 2b. are not met. 4. If baking is required, devices may be baked for: 192 hours at 40 °C + 5 °C/- 0 °C and < 5 % RH (dry air/nitrogen) or 96 hours at 60 °C ± 5 °C and < 5 % RH for all device containers or 24 hours at 125 °C ± 5 °C not suitable for reels or tubes	
Bag Seal Date: _____ (If blank, see barcode label)		
Note: Level and body temperature defined by EIA JEDEC Standard J-STD-020		

22522

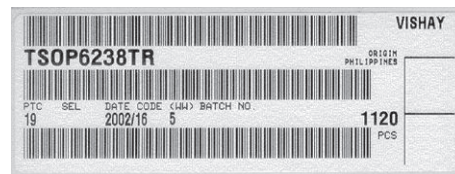
EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

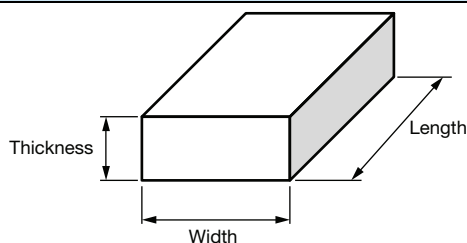
The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



16962

OUTER PACKAGING

The sealed reel is packed into a pizza box.

CARTON BOX DIMENSIONS in millimeters

22127

	THICKNESS	WIDTH	LENGTH
Pizza Box (SMD and Heimdall) (Taping in reels)	50	340	340



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

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